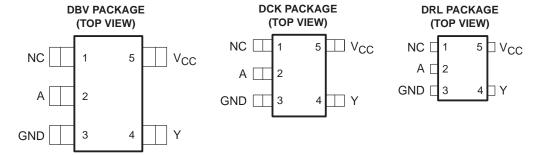
- Operating Range 2-V to 5.5-V V_{CC}
- Unbuffered Output
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)



NC – No internal connection

See mechanical drawings for dimensions.

description/ordering information

The SN74AHC1GU04 contains a single inverter gate. The device performs the Boolean function $Y = \overline{A}$. Internal circuitry consists of a single-stage inverter that can be used in analog applications, such as crystal oscillators.

ORDERING INFORMATION

| TA | PACKAGE | <u>:</u> † | ORDERABLE PART NUMBER | TOP-SIDE MARKING‡ |
|---------------|---------------------|--------------|--------------------------|----------------------|
| | COT (COT 00) DDV | Reel of 3000 | SN74AHC1GU04DBVR | A114 |
| -40°C to 85°C | SOT (SOT-23) – DBV | Reel of 250 | SN74AHC1GU04DBVT | AU4_ |
| | COT (CC 70) DCK | Reel of 3000 | SN74AHC1GU04DCKR | AD |
| | SOT (SC-70) – DCK | Reel of 250 | SN74AHC1GU04DCKT | AD_ |
| | SOT (SOT-553) – DRL | Reel of 4000 | SN74AHC1GU04DRLR | AD_ |

[†] Package drawings, standard packing quantities, thermal data, symbolization, and PCB design guidelines are available at www.ti.com/sc/package.

FUNCTION TABLE

| INPUT A | OUTPUT Y |
|------------|-------------|
| Н | L |
| L | Н |

logic diagram (positive logic)





Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.



[‡]The actual top-side marking has one additional character that designates the assembly/test site.

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absolute maximum ratings over operating free-air temperature range (unless otherwise noted)†

| Supply voltage range, V _{CC} | 0.5 V to 7 V |
|--|---|
| Input voltage range, V _I (see Note 1) | 0.5 V to 7 V |
| Output voltage range, VO (see Note 1) | \dots -0.5 V to V _{CC} + 0.5 V |
| Input clamp current, I_{IK} ($V_I < 0$) | –20 mA |
| Output clamp current, I_{OK} ($V_O < 0$ or $V_O > V_{CC}$) | ±20 mA |
| Continuous output current, I_O ($V_O = 0$ to V_{CC}) | ±25 mA |
| Continuous current through V _{CC} or GND | ±50 mA |
| Package thermal impedance, θ_{JA} (see Note 2): DBV package | 206°C/W |
| DCK package | 252°C/W |
| DRL package | 142°C/W |
| Storage temperature range, T _{stg} | –65°C to 150°C |

[†] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions (see Note 3)

| | | | MIN | MAX | UNIT |
|-----------------|--|--|-----|-----|------|
| VCC | Supply voltage | 2 | 5.5 | V | |
| | V _{CC} = 2 V | | 1.7 | | |
| V_{IH} | High-level input voltage V _{CC} = 3 V | V _{CC} = 3 V | 2.4 | | V |
| | | V _{CC} = 5.5 V | 4.4 | | |
| | | V _{CC} = 2 V | | 0.3 | |
| V_{IL} | Low-level input voltage V _{CC} = 3 V | | | 0.6 | V |
| | | V _{CC} = 5.5 V | | 1.1 | |
| ٧ _I | Input voltage | · | 0 | 5.5 | V |
| ٧o | Output voltage | | 0 | Vcc | V |
| | | V _{CC} = 2 V | | -50 | μΑ |
| lон | High-level output current | V _{CC} = 3.3 V ± 0.3 V | | -4 | |
| | | $V_{CC} = 5 V \pm 0.5 V$ | | -8 | mA |
| l _{OL} | | V _{CC} = 2 V | | 50 | μΑ |
| | Low-level output current | $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$ | | 4 | |
| | | $V_{CC} = 5 V \pm 0.5 V$ | | 8 | mA |
| T _A | Operating free-air temperature | | -40 | 85 | °C |

NOTE 3: All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.



NOTES: 1. The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

^{2.} The package thermal impedance is calculated in accordance with JESD 51-7.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| B4 B 444 E E B | T-07 001/DITIONS | ., | T _A = 25°C | | | | | |
|-----------------|----------------------------------|--------------|-----------------------|-----|------|------|------|------|
| PARAMETER | TEST CONDITIONS | VCC | MIN | TYP | MAX | MIN | MAX | UNIT |
| | | 2 V | 1.8 | 2 | | 1.8 | | |
| | $I_{OH} = -50 \mu\text{A}$ | 3 V | 2.7 | 3 | | 2.7 | | |
| VOH | | 4.5 V | 4 | 4.5 | | 4 | | V |
| | $I_{OH} = -4 \text{ mA}$ | 3 V | 2.58 | | | 2.48 | | |
| | $I_{OH} = -8 \text{ mA}$ | 4.5 V | 3.94 | | | 3.8 | | |
| | | 2 V | | | 0.2 | | 0.2 | |
| | I _{OL} = 50 μA | 3 V | | | 0.3 | | 0.3 | |
| V _{OL} | | 4.5 V | | | 0.5 | | 0.5 | V |
| | I _{OL} = 4 mA | 3 V | | | 0.36 | | 0.44 | |
| | I _{OL} = 8 mA | 4.5 V | | | 0.36 | | 0.44 | |
| lį | V _I = 5.5 V or GND | 0 V to 5.5 V | | | ±0.1 | | ±1 | μΑ |
| Icc | $V_I = V_{CC}$ or GND, $I_O = 0$ | 5.5 V | | | 1 | | 10 | μΑ |
| Ci | $V_I = V_{CC}$ or GND | 5 V | | 2 | 10 | | 10 | pF |

switching characteristics over recommended operating free-air temperature range, $V_{CC}=$ 3.3 V \pm 0.3 V (unless otherwise noted) (see Figure 1)

| 242445752 | FROM | то | OUTPUT | | TO OUTPUT T _A = 25°C | | TO OUTPUT TA = 25°C | | TO OUTPUT TA = 25°C | | | | |
|------------------|---------|----------|------------------------|-----|---------------------------------|------|---------------------|-----|---------------------|------|---|----|--|
| PARAMETER | (INPUT) | (OUTPUT) | CAPACITANCE | MIN | TYP | MAX | MIN | MAX | UNIT | | | | |
| t _{PLH} | | V | C _L = 15 pF | | | 5 | 7.1 | 1 | 8.5 | | | | |
| tPHL | Α | Y | | | 5 | 7.1 | 1 | 8.5 | ns | | | | |
| t _{PLH} | ^ | V | V | V | V | V . | 0: 50.55 | | 7.5 | 10.6 | 1 | 12 | |
| t _{PHL} | A | Ť | C _L = 50 pF | | 7.5 | 10.6 | 1 | 12 | ns | | | | |

switching characteristics over recommended operating free-air temperature range, $V_{CC}=5~V\pm0.5~V$ (unless otherwise noted) (see Figure 1)

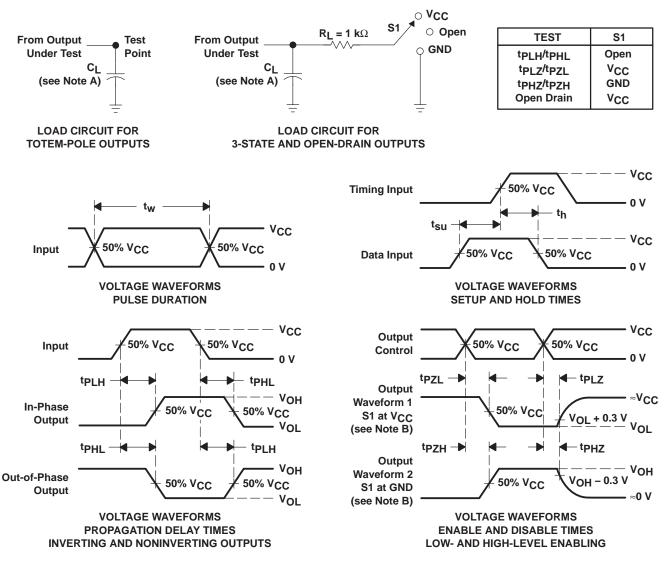
| DADAMETED | FROM | то оитрит | | FROM TO OUTPUT TA = 25°C | | ; | 84181 | N BAAV | LINUT | | | |
|------------------|-----------------------|-----------|------------------------|--------------------------|----------|------------|-------|--------|-------|---|---|----|
| PARAMETER | ETER (INPUT) (OUTPUT) | | CAPACITANCE | MIN | TYP | MAX | MIN | MAX | UNIT | | | |
| t _{PLH} | | Υ | C _L = 15 pF | 0. 45.5 | | 3.5 | 5.5 | 1 | 6 | | | |
| t _{PHL} | А | | | | 3.5 | 5.5 | 1 | 6 | ns | | | |
| t _{PLH} | _ | V | | V | V C: -50 | C: _ 50 pF | | 5 | 7 | 1 | 8 | 20 |
| ^t PHL | A | ī | C _L = 50 pF | | 5 | 7 | 1 | 8 | ns | | | |

operating characteristics, $V_{CC} = 5 \text{ V}$, $T_A = 25^{\circ}\text{C}$

| | PARAMETER | TEST C | ONDITIONS | TYP | UNIT |
|-----------------|-------------------------------|----------|-----------|-----|------|
| C _{pd} | Power dissipation capacitance | No load, | f = 1 MHz | 7.3 | pF |



PARAMETER MEASUREMENT INFORMATION



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, $Z_O = 50 \Omega$, $t_f \leq 3$ ns. $t_f \leq 3$ ns.
- D. The outputs are measured one at a time with one input transition per measurement.

Figure 1. Load Circuit and Voltage Waveforms







com 8-Aug-2005

PACKAGING INFORMATION

| Orderable Device | Status ⁽¹⁾ | Package Type | Package Drawing | Pins | Package Qty | e Eco Plan ⁽²⁾ | Lead/Ball Finish | MSL Peak Temp ⁽³⁾ |
|------------------|-----------------------|-----------------|--------------------|------|----------------|---------------------------|------------------|------------------------------|
| 74AHC1GU04DBVRG4 | ACTIVE | SOT-23 | DBV | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| 74AHC1GU04DBVTE4 | ACTIVE | SOT-23 | DBV | 5 | 250 | Pb-Free (RoHS) | CU NIPDAU | Level-1-260C-UNLIM |
| 74AHC1GU04DCKRG4 | ACTIVE | SC70 | DCK | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| 74AHC1GU04DCKTG4 | ACTIVE | SC70 | DCK | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AHC1GU04DBVR | ACTIVE | SOT-23 | DBV | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AHC1GU04DBVT | ACTIVE | SOT-23 | DBV | 5 | 250 | Pb-Free (RoHS) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AHC1GU04DCKR | ACTIVE | SC70 | DCK | 5 | 3000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AHC1GU04DCKT | ACTIVE | SC70 | DCK | 5 | 250 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |
| SN74AHC1GU04DRLR | ACTIVE | SOP | DRL | 5 | 4000 | Green (RoHS & no Sb/Br) | CU NIPDAU | Level-1-260C-UNLIM |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS) or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

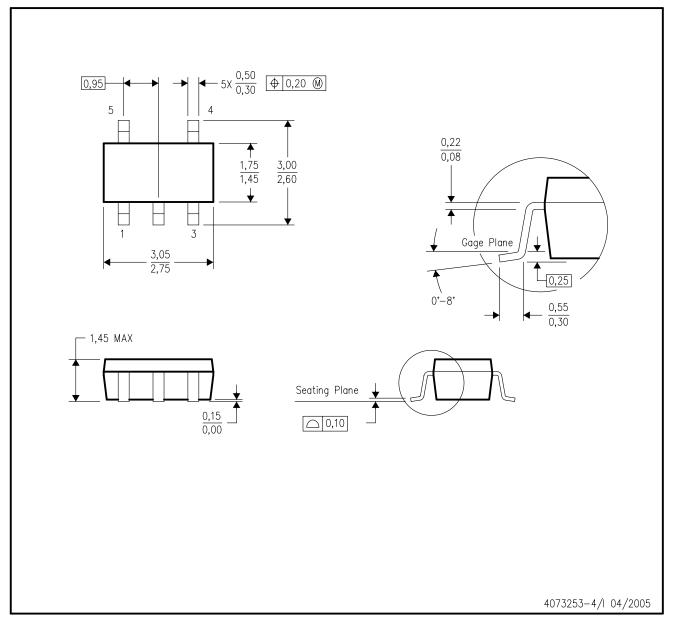
(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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DBV (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE



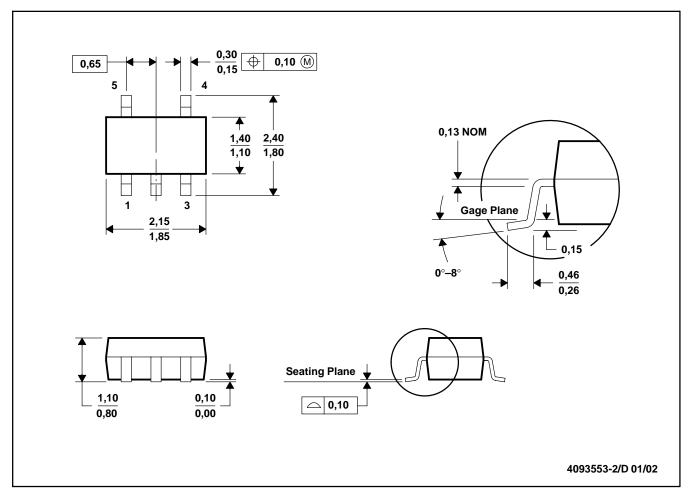
NOTES:

- All linear dimensions are in millimeters.
- This drawing is subject to change without notice.
- C. Body dimensions do not include mold fla D. Falls within JEDEC MO—178 Variation AA. Body dimensions do not include mold flash or protrusion.



DCK (R-PDSO-G5)

PLASTIC SMALL-OUTLINE PACKAGE

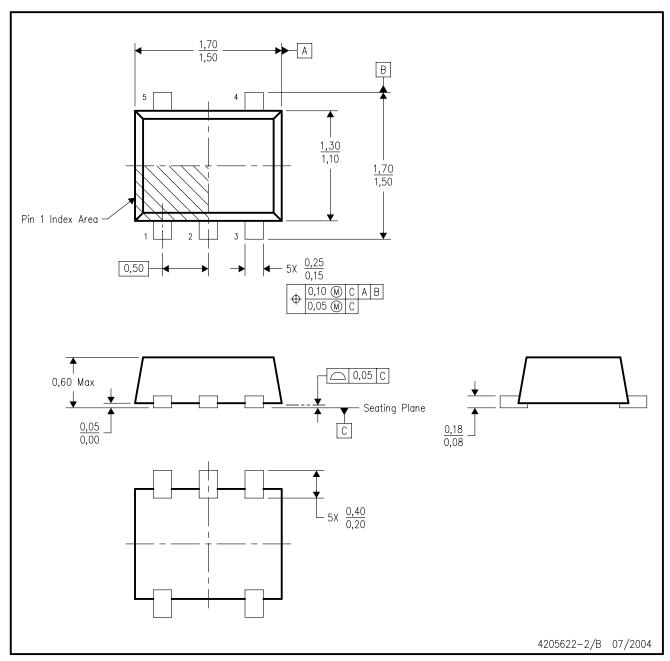


NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion.
- D. Falls within JEDEC MO-203

DRL (R-PDSO-N5)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. JEDEC package registration is pending.



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